

## DECLARATION AND POWER-OF ATTORNEY

U.S.A.

Attorney Ref. No.

As a below-named inventor, I hereby declare: My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled \_\_\_\_\_

MODULATION SYSTEM

\_\_\_\_\_, the specification of which

(Check one)

☒ is attached hereto.☐ was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_

and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above, and acknowledge a duty to disclose information which is material to the examination of this application under 37 CFR 1.56(a). I hereby claim priority benefits under 35 U.S.C. 119 based on any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate on the present invention, filed before the application(s) on which priority is claimed.

## FOREIGN APPLICATION(S), IF ANY, REFERRED TO ABOVE

COUNTRY	APPLICATION NUMBER	DATE	PRIORITY CLAIMED
Japan	2001-7389	January 16, 2001	YES <input checked="" type="checkbox"/> NO <input type="checkbox"/>
Japan	2001-13312	January 22, 2001	YES <input checked="" type="checkbox"/> NO <input type="checkbox"/>
			YES <input type="checkbox"/> NO <input type="checkbox"/>

I hereby claim benefit under 35 U.S.C. 120 of any U.S. application(s) listed below. If the subject matter of any claim(s) of this application is not disclosed in the prior U.S. application(s) as required by paragraph one of 35 U.S.C. 112. I acknowledge as duty to disclose material information as defined in 37 C.F.R. 1.56(a) regarding occurrences between the filing date of the prior application(s) and the national or PCT international filing date of this application.

APPLICATION SERIAL NUMBER	DATE	STATUS

I hereby appoint Louis Woo, RN 31,730 and Robert R. Priddy, RN 20,169 as my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Address all communications to **LAW OFFICES OF LOUIS WOO, 1901 North Fort Myer Drive, Suite 501, Arlington, Virginia 22209**

All statements made herein of my own knowledge are true. All statements made on information and belief are believed to be true. These statements were made with knowledge that wilful false statements and the like so made are punishable by fine, imprisonment, or both, under 18 U.S.C. 1001 and may jeopardize the validity of the application or any patent issuing thereon.

Note: Please sign one full given name and your surname, using initials where appropriate for other names. It is important that the name be consistent throughout the application papers. Signing of an application more than five weeks prior to filing or an undated application is not acceptable to the Patent and Trademark Office except for receiving an initial filing date.

1. Full name of inventor Atsushi Hayami Date: November 21, 2001

Inventor's signature

*Atsushi Hayami*

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(X) Additional inventors listed

ADDED PAGE TO COMBINED DECLARATION AND POWER OF ATTORNEY  
FOR SIGNATURE BY SECOND AND SUBSEQUENT INVENTORS

2. Full name of inventor Takayuki Sugahara Date: November 21, 2001

Inventor's signature Takayuki Sugahara

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3. Full name of inventor Date: \_\_\_\_\_

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4. Full name of inventor Date: \_\_\_\_\_

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